Unit: mm

TOSHIBA Diode Silicon Epitaxial Schottky Barrier Type

DSF521

High Speed Switching Application

Low forward voltage : $V_{F(3)} = 0.5V$ (max.)

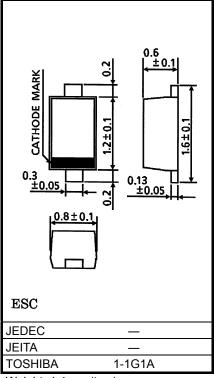
Abusolute Maximum Ratings (Ta = 25°C)

| Characteristic | Symbol | Rating | Unit |
|--------------------------------|------------------|------------|------|
| Reverse voltage | V_{R} | 30 | V |
| Maximum (peak) forward current | I _{FM} | 300 | mA |
| Average forward current | Io | 200 | mA |
| Surge current (10ms) | I _{FSM} | 1 | Α |
| Power dissipation | P* | 150 | mW |
| Junction temperature | Tj | 125 | °C |
| Storage temperature range | T _{stg} | −55 to 125 | °C |
| Operating temperature range | T _{opr} | -40 to 100 | °C |

^{*:} Mounted on a glass epoxy circuit board of 20 × 20 mm, pad dimension of 4 × 4 mm.

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Weight: 1.4 mg (typ.)

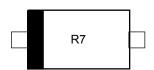
Electrical Characteristics (Ta = 25°C)

| Characteristic | Symbol | Test Circuit | Test Condition | Min | Тур. | Max | Unit | |
|-------------------|--------------------|-----------------|-------------------------------|-----|------|-----|------|--|
| Forward voltage | V _{F (1)} | _ | I _F = 1 mA | 1 | 0.2 | _ | | |
| | V _{F (2)} | _ | I _F = 5 mA | _ | 0.24 | - | V | |
| | V _{F (3)} | _ | I _F = 200 mA | _ | 0.45 | 0.5 | | |
| Reverse current | I _{R (1)} | _ | V _R = 10 V | _ | _ | 20 | | |
| | I _{R (2)} | _ | V _R = 30 V | _ | _ | 30 | μA | |
| Total capacitance | C _T | _ | V _R = 0, f = 1 MHz | _ | 32 | _ | pF | |

Equivalent Circuit (top view)



Marking



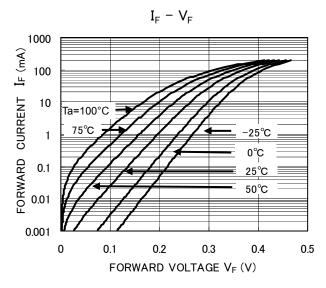
Handling Precaution

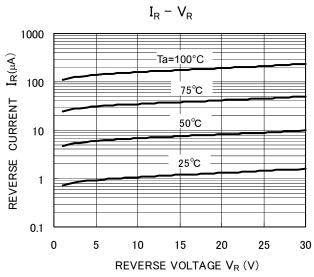
Schottky barrier diodes have reverse current characteristic compared to the other diodes.

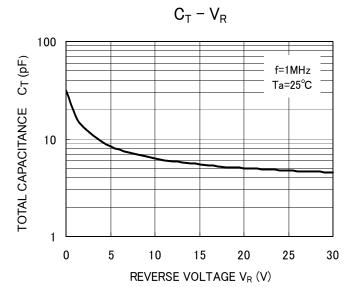
There is a possibility SBD may cause thermal runaway when it is used under high temperature or high voltage.

Please take forward and reverse loss into consideration during design.

2 2009-04-28







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